

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

In re application of : **Attn: APPLICATION BRANCH**

Koji MISHIMA et al. : Attorney Docket No. 2004_0611

Serial No. NEW :

Filed April 20, 2004 :

PLATING METHOD AND PLATING
APPARATUS

**(Rule 1.53(b) Divisional
of Serial No. 09/955,115,
Filed September 19, 2001)**

THE COMMISSIONER IS AUTHORIZED
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CLAIM OF PRIORITY UNDER 35 USC 119

Commissioner for Patents
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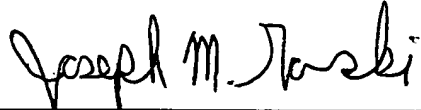
Sir:

Applicants in the above-entitled application hereby claim the date of priority under the International Convention of Japanese Patent Application No. 2000-285740, filed September 20, 2000, Japanese Patent Application No. 2000-294665, filed September 27, 2000 and Japanese Patent Application No. 2001-248125, filed August 17, 2001, as acknowledged in the Declaration of this application.

Certified copies of said Japanese Patent Application are of record in parent application Serial No. 09/955,115, filed September 19, 2001.

Respectfully submitted,

Koji MISHIMA et al.

By 

Joseph M. Gorski
Registration No. 46,500
Attorney for Applicants

JMG/edg
Washington, D.C. 20006-1021
Telephone (202) 721-8200
Facsimile (202) 721-8250
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